

STPS6M100DEE

High voltage power Schottky rectifier

Datasheet - production data

Features

- Negligible switching losses
- Extremely fast switching
- Low thermal resistance
- High junction temperature capability
- ECOPACK[®]2 compliant component

Description

This Schottky rectifier is designed for switch mode power supply and high frequency DC to DC converters.

Packaged in PowerFLAT™, this device is intended for use in low voltage, high frequency, inverters, free-wheeling, by-pass diode and polarity protection applications. Its low profile was especially designed to be used in applications with space-saving constraints.

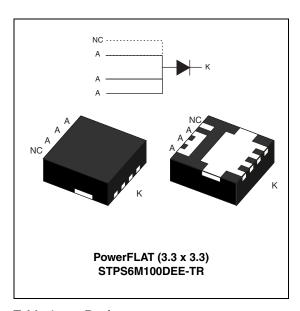


Table 1. Device summary

Symbol	Value
I _{F(AV)}	6 A
V_{RRM}	100 V
T _j (max)	150 °C
V _F (typ)	0.64 V

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1 Characteristics

Table 2. Absolute ratings (limiting values T_{amb} = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	100	V	
I _{F(RMS)}	Forward rms current	15	Α	
I _{F(AV)}	Average forward current	Tc = 130 °C δ = 0.5	6	Α
I _{FSM}	Surge non repetitive forward current	tp = 10 ms sinusoidal	100	Α
P _{ARM} ⁽¹⁾	Repetitive peak avalanche power	480	W	
T _{stg}	Storage temperature range	-65 to +150	°C	
T _j	Maximum operating junction tempera	150	°C	

For pulse time duration deratings, please refer to Figure 3. More details regarding the avalanche energy
measurements and diode validation in the avalanche are provided in the STMicroelectronics Application
notes AN1768, "Admissible avalanche power of Schottky diodes" and AN2025, "Converter improvement
using Schottky rectifier avalanche specification".

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	4	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V - V	-		30	μΑ
neverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$	-	5	15	mA	
V _E ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 6A			0.78	V
v _F .	Torward voltage drop	T _j = 125 °C		-	0.58	0.64	V

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.56 \text{ x I}_{F(AV)} + 0.0133 \text{ x I}_{F^2(RMS)}^2$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

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Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature($\delta = 0.5$)

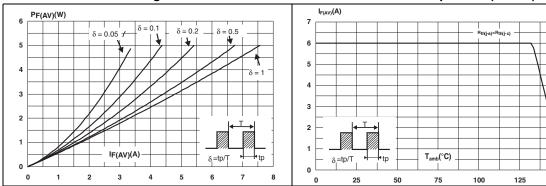


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Relative variation of thermal impedance junction to case versus pulse duration

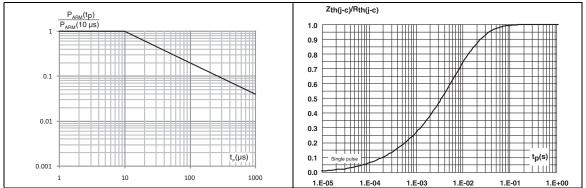
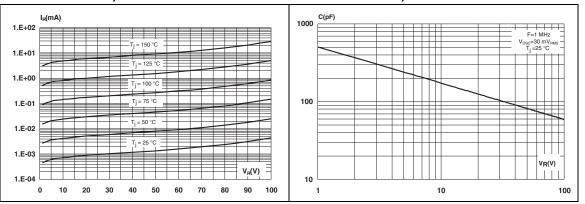


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

Figure 6. Junction capacitance versus reverse voltage applied (typical values)

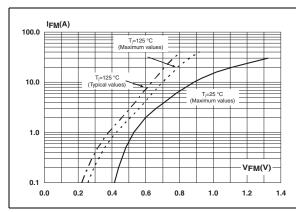


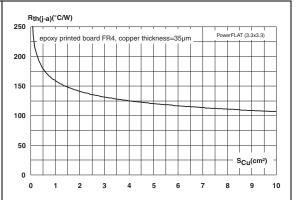
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Figure 7. Forward voltage drop versus forward current

Figure 8. Thermal resistance junction to ambient versus copper surface under tab





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2 Package information

- Epoxy meets UL94,V0
- Lead-free package

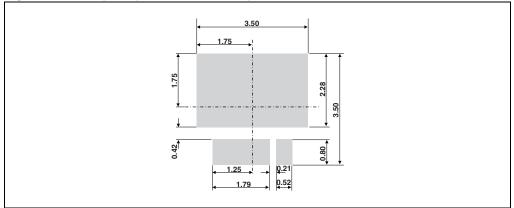
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 9. PowerFLAT-3.3x3.3-8L dimensions (definitions)

Table 5. PowerFLAT-8L dimensions (values)

	Dimensions					
Ref.	Ref. Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.95	1.00	1.05	0.037	0.039	0.041
A3		0.20			0.0079	
A4		0.20			0.0079	
b	0.30	0.37	0.44	0.012	0.015	0.017
D	3.20	3.30	3.40	0.126	0.130	0.134
D2	2.24	2.31	2.38	0.088	0.091	0.094
D3	1.60	1.67	1.74	0.063	0.066	0.069
е		0.65			0.026	
Е	3.20	3.30	3.40	0.126	0.130	0.134
E2	1.68	1.75	1.82	0.066	0.069	0.072
L	0.31	0.38	0.45	0.012	0.015	0.018
L1	0.55	0.62	0.69	0.22	0.024	0.027
L2	0.86	0.93	1.00	0.034	0.037	0.039

Figure 10. Footprint (dimensions in mm)



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS6M100DEE-TR	S6M100	PowerFLAT (3.3 x 3.3)	34 mg	3000	Tape and reel 13" reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
09-Sep-2012	1	First issue.

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